

To our customers,

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## Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

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Readme for Flash memory tool program sample  
H8S,H8SX Family Flash memory load is supported  
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### **1.Operation-confirmed flash memory products**

The operation of this sample program has been confirmed using the following flash memory products.

TOSHIBA CORPORATION TC58FV160AFT-70

### **2.Operation confirmation environment of sample program**

The operation was confirmed by this sample program under the following environment.

Hardware condition: H8SX/1651 CPU board is used.

---Connection information of flash memory

[Word mode]

- CPU Connection information: Word mode connection(16-bit bus width)
- Address-line connection information:Connect A1 of the H8SX microcomputer to A0 of flash memory

---Address of flash memory: Allocated from address 200000 (CS1 area)  
Address 0 (CS0 area) is allocated SRM

#### **Operation confirmation environment:**

- The H8SX/1651 CPU board (HSB8SX1651)
- The E10A-USB emulator
- The HEW4 Version 4.02.00